

ON Semiconductor®

FCH041N60F-F085

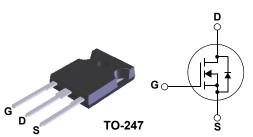
N-Channel SuperFET II FRFET MOSFET 600 V, 76 A, 41 m Ω

Features

- Typical $R_{DS(on)}$ = 36 m Ω at V_{GS} = 10 V, I_D = 38 A
- Typical Q_{g(tot)} = 267 nC at V_{GS} = 10V, I_D = 38 A
- Low Effective Output Capacitance (Typical C_{oss(eff.)} = 720 nF)
- 100% Avalanche Tested
- Qualified to AEC Q101
- RoHS Compliant

Description

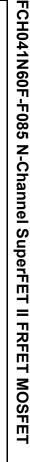
SuperFET® II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive. SuperFETI II FRET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



Application

Automotive On Board Charger

Automotive DC/DC converter for HEV



Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain to Source Voltage		600	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	Drain Current - Continuous (V _{GS} =10)	T _C = 25°C	76	А	
	Pulsed Drain Current		See Fig 4	А	
E _{AS}	Single Pulse Avalanche Rating	(Note 1)	2025	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt	(Note 2)	50	v/115	
P _D	Power Dissipation		595	W	
	Derate Above 25°C		4.76	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	°C	
$R_{\theta JC}$	Maximum Thermal Resistance Junction to Case		0.21	°C/W	
$R_{ ext{ heta}JA}$	Maximum Thermal Resistance Junction to Ambient	(Note 3)	40	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH041N60F	FCH041N60F-F085	TO-247	-	-	30

Notes:

1: Starting $T_J = 25^{\circ}$ C, L = 18mH, $I_{AS} = 15A$, $V_{DD} = 100V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche.

2: $I_{SD} \le 38A$, di/dt $\le 200 \text{ A/us}$, $V_{DD} \le 380V$, starting $T_J = 25^{\circ}C$.

3: $R_{0,JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{0,JC}$ is guaranteed by design, while $R_{0,JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Cha	racteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	600	-	-	V
I _{DSS}	Drain to Source Leakage Current	V_{DS} =600V, T_{J} = 25°C	-	-	10	μA
	Drain to Source Leakage Current	$V_{GS} = 0V$ $T_J = 150^{\circ}C(Note 4)$	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V	-	-	±100	nA
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		4	5	V
On Cha	racteristics					
r _{DS(on)}	Drain to Source On Resistance	$I_D = 38A,$ $T_J = 25^{\circ}C$ $V_{GS} = 10V$ $T_J = 150^{\circ}C(Note 5)$	-	36 89	41 98	mΩ mΩ
Dynam i C _{iss}	ic Characteristics	V 400V V 0V	_	10900	-	pF
C _{oss}	Output Capacitance	─V _{DS} = 100V, V _{GS} = 0V, f = 1MHz	-	360	-	pF
C _{rss}	Reverse Transfer Capacitance		-	4.4	-	pF
C _{oss(eff)}	Effective Output Capacitance	V_{DS} = 0V to 480V, V_{GS} = 0V	-	720	-	pF
()	Gate Resistance	f = 1MHz	-	0.7	-	Ω
R _g			-	267	347	nC
R _g Q _{g(ToT)}	Total Gate Charge	11 00011				
Q _{g(ToT)}	Threshold Gate Charge	$V_{DD} = 380V$	-	20	26	nC
$\frac{R_g}{Q_{g(ToT)}}$ $\frac{Q_{g(th)}}{Q_{gs}}$	Č Č	V _{DD} = 380V I _D = 38A V _{GS} = 10V	-	20 59	26 -	nC nC

Switching Characteristics

t _{on}	Turn-On Time		-		242	ns
t _{d(on)}	Turn-On Delay Time		-	63	-	ns
t _r	Rise Time	V _{DD} = 380V, I _D = 38A, V _{GS} = 10V, R _G = 4.7Ω	-	48	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R _G = 4.7Ω	-	214	-	ns
t _f	Fall Time		-	33	-	ns
t _{off}	Turn-Off Time		-	-	514	ns

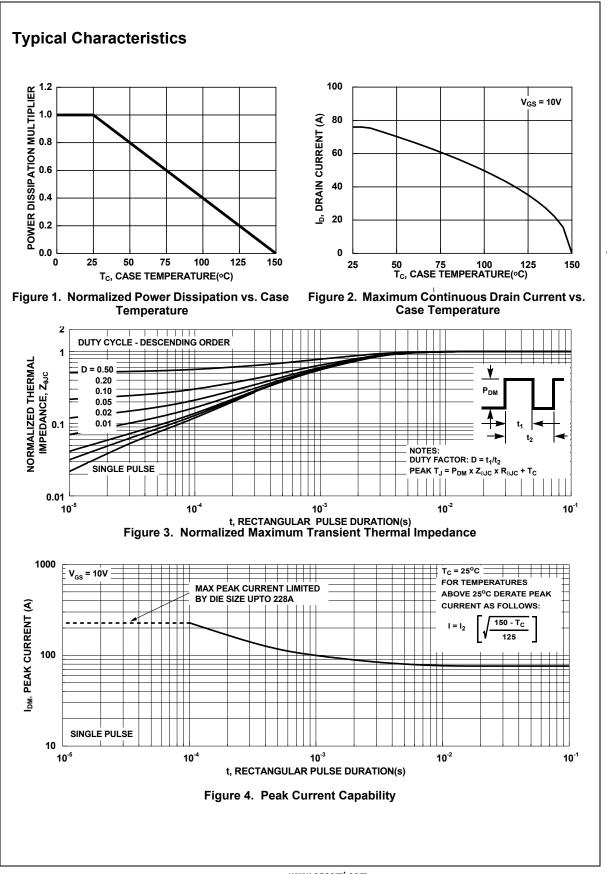
Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	I _{SD} = 38A, V _{GS} = 0V	-	-	1.2	V
T _{rr}	Reverse Recovery Time	I _F = 38A, dI _{SD} /dt = 100A/μs	-	219	-	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} = 480V	-	1.9	-	μC

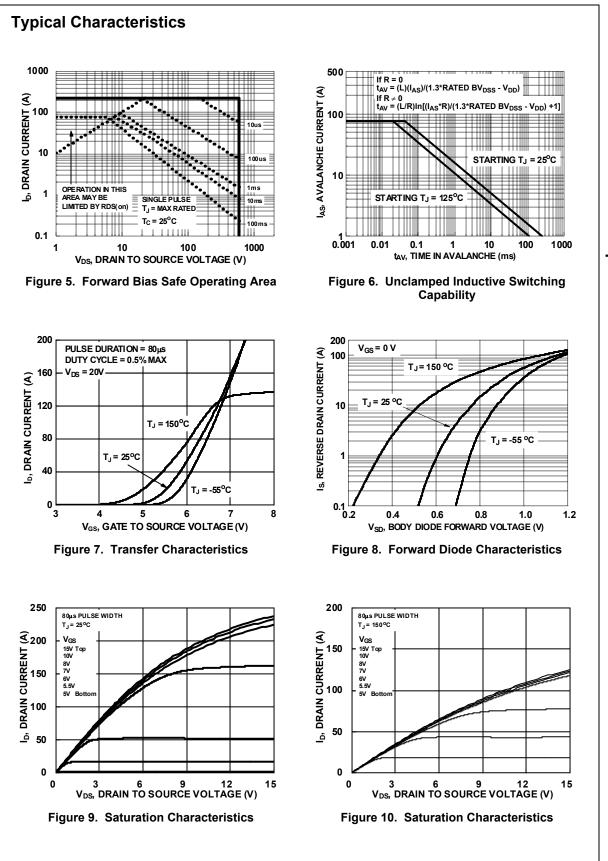
Notes:

4: The maximum value is specified by design at $T_J = 150^{\circ}$ C. Product is not tested to this condition in production.

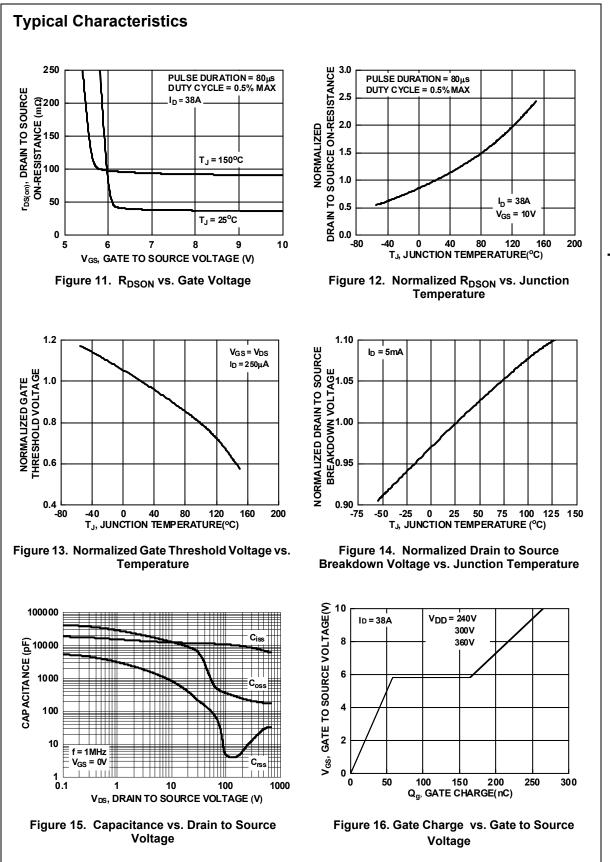




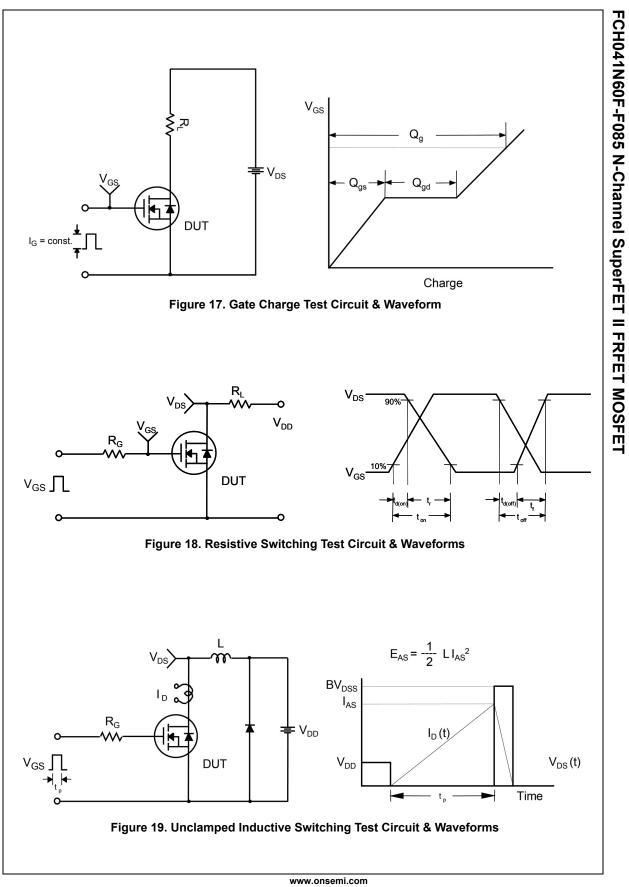
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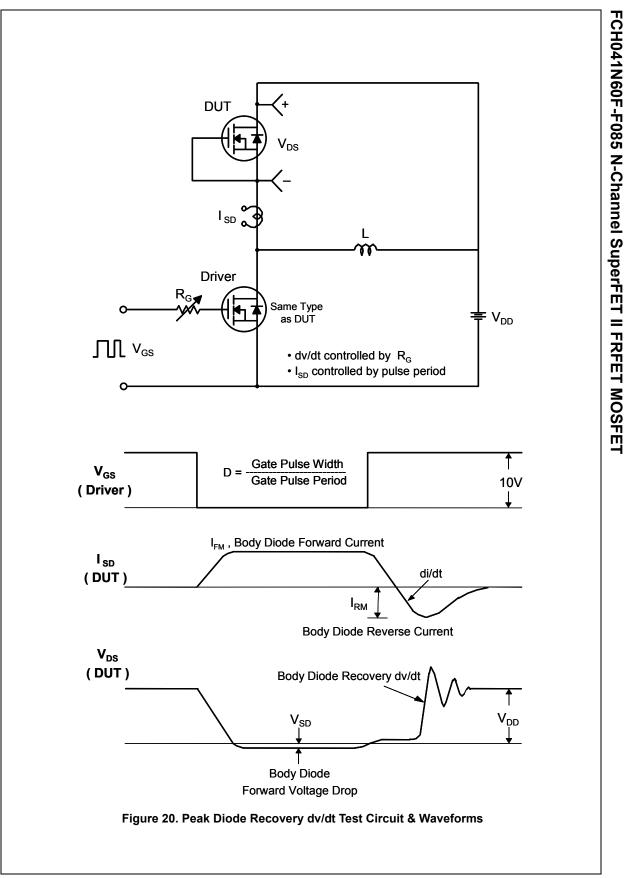
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